

**3.125 Gbps LVDS Buffers
with
Pre-emphasis and Equalization
(DS25BR100/110/120)
Evaluation Kit**

USER MANUAL

Part Number: DS25BR100EVK

For the latest documents concerning these products and evaluation kit, visit lvds.national.com. Schematics and gerber files are also available at lvds.national.com.

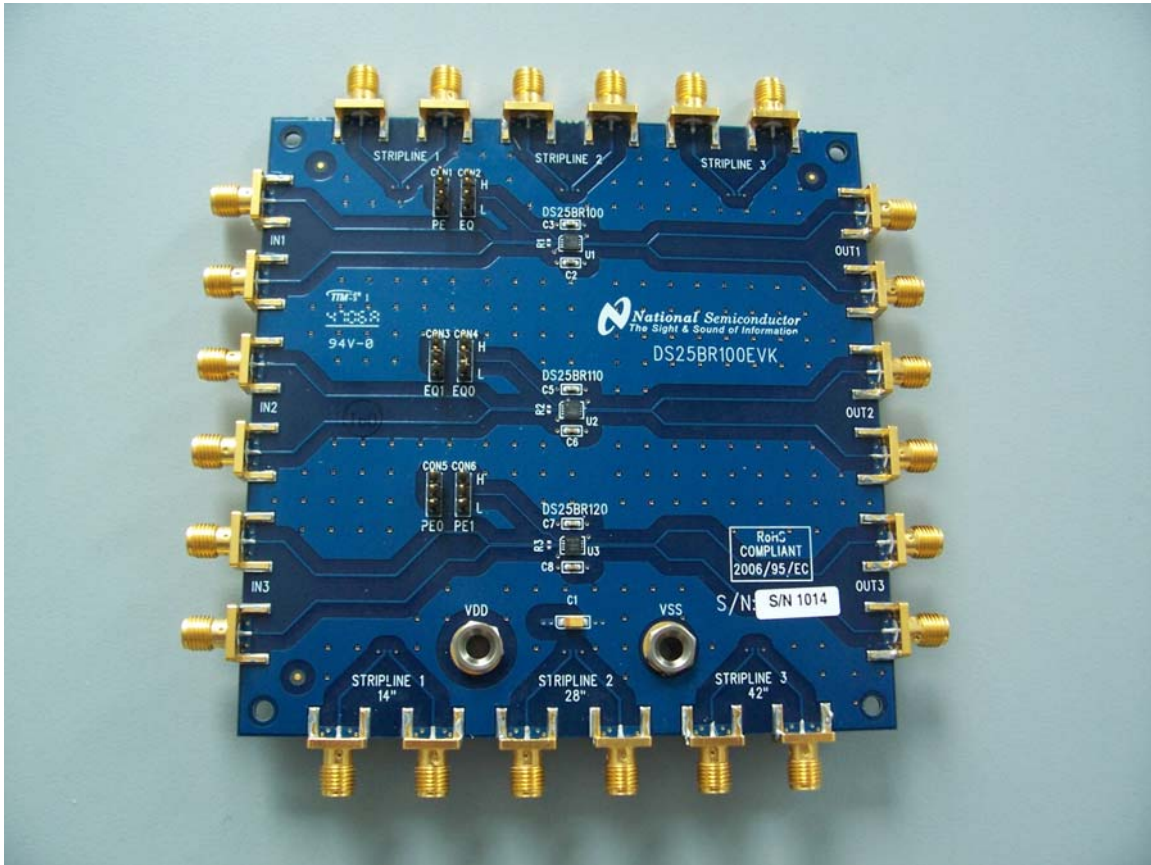
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Overview

The DS25BR100EVK is an evaluation kit designed for demonstrating performance of the 3.125 Gbps LVDS Single Channel Buffers with Transmit Pre-emphasis and Receive Equalization family (DS25BR100, DS25BR110 and DS25BR120). The evaluation kit provides all three devices on a single board and three FR4 striplines (14 (~35), 28 (~75) and 42 (~105) inches (cm) in length) for exercising devices' signal conditioning features (pre-emphasis and equalization).

The purpose of this document is to: familiarize you with the DS25BR100EVK, suggest the test setup procedures and instrumentation, and guide you through some typical measurements that demonstrate performance of the chipset in typical applications.



DS25BR100EVK Description

Figure 1 shows the top layer drawing of the PCB with the silkscreen annotations. It is a 4.5 by 4.5 inch eight-layer PCB that has a three-device layout capable of demonstrating performance and all features of the DS25BR100, DS25BR110 and DS25BR120. In addition, three microstrips allow easy evaluation of transmit pre-emphasis and receive equalization.

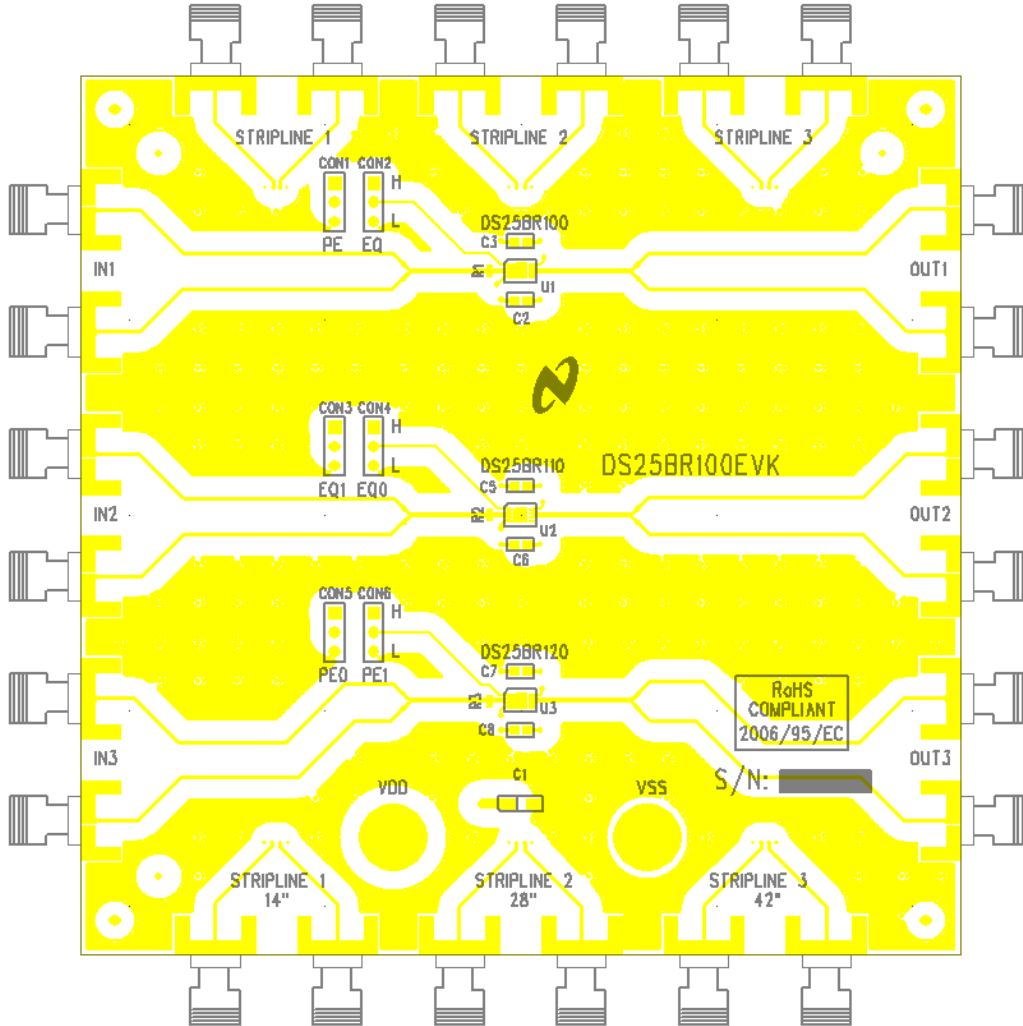


Figure 1. Driver Board

Connector	Device	Function
CON1, CON2	U1	Select PE or EQ Level
CON3, CON4	U2	Select EQ Level
CON5, CON6	U3	Select PE Level

Table 1. Driver Board Connector-Device-Function Cross Reference

DS25BR100 (U1) Evaluation

The DS25BR100 is a 3.125 Gbps LVDS buffer featuring two levels of transmit pre-emphasis (Off and Medium) and two levels of receive equalization (Low and Medium). The following is a recommended test setup procedure for the device evaluation. Figure 2 depicts a typical setup and instrumentation used for the device evaluation.

1. Apply the power to the device (3.3V typical) between VDD and VSS banana plug receptacles.
2. Connect desired STRIPLINE(s) to the input and / or output of the device using short 50-ohm coaxial cables (e.g. PE-SR402-AL from www.pasternack.com).
3. Connect a signal source (i.e. signal generator or an LVDS driver) to the IN1 inputs on the board and adjust the signal parameters (VOH, VOL, VCM) so that they comply with the device input recommendations.
4. Select equalization level by setting the EQ pin (CON2) to L (for Low setting) or H (for Medium setting).
5. If a STRIPLINE is connected to the device outputs, select pre-emphasis level by setting the PE pin (CON1) to L (for Off setting) or H (for Medium setting).
6. Connect the OUT1 outputs to an oscilloscope and view the output signals with an oscilloscope with the bandwidth of at least 5 GHz.

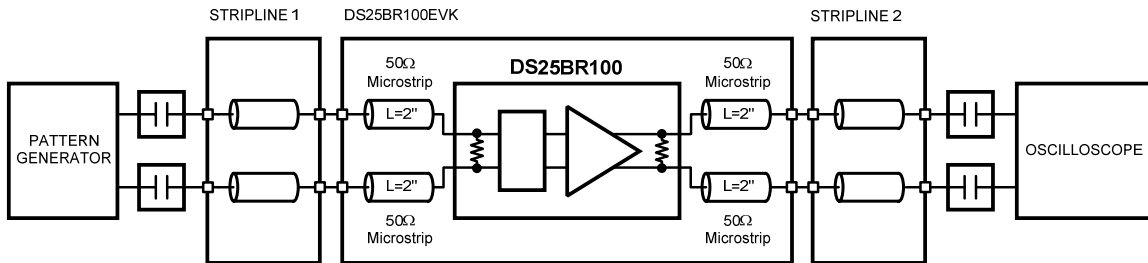


Figure 2. DS25BR100 Test Setup Example

DS25BR110 (U2) Evaluation

The DS25BR110 is a 3.125 Gbps LVDS buffer featuring four levels of receive equalization (Off, Low, Medium and High). The following is a recommended test setup procedure for the device evaluation. Figure 3 depicts a typical setup and instrumentation used for the device evaluation.

1. Apply the power to the device (3.3V typical) between VDD and VSS banana plug receptacles.
2. Connect desired STRIPLINE to the input of the device using short 50-ohm coaxial cables (e.g. PE-SR402-AL from www.pasternack.com).
3. Connect a signal source (i.e. signal generator or an LVDS driver) to the IN2 inputs on the board and adjust the signal parameters (VOH, VOL, VCM) so that they comply with the device input recommendations.
4. Select equalization level by setting the EQ0 (CON4) and EQ1 (CON3) pins to L or H. Refer to Table 2.

EQ1	EQ0	Equalization Level
0	0	Off
0	1	Low
1	0	Medium
1	1	High

Table 2. Equalization Level Selection

5. Connect the OUT2 outputs to an oscilloscope and view the output signals with an oscilloscope with the bandwidth of at least 5 GHz.

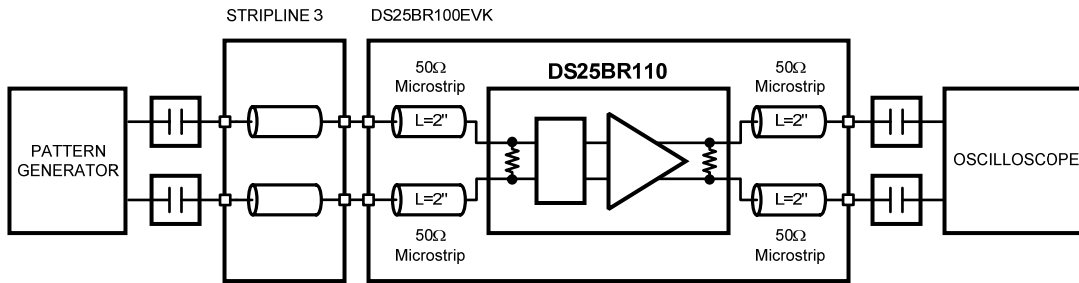


Figure 3. DS25BR110 Test Setup Example

DS25BR120 (U3) Evaluation

The DS25BR120 is a 3.125 Gbps LVDS buffer featuring four levels of transmit pre-emphasis (Off, Low, Medium and High). The following is a recommended test setup procedure for the device evaluation. Figure 4 depicts a typical setup and instrumentation used for the device evaluation.

1. Apply the power to the device (3.3V typical) between VDD and VSS banana plug receptacles.
2. Connect desired STRIPLINE to the output of the device using short 50-ohm coaxial cables (e.g. PE-SR402-AL from www.pasternack.com).
3. Connect a signal source (i.e. signal generator or an LVDS driver) to the IN3 inputs on the board and adjust the signal parameters (VOH, VOL, VCM) so that they comply with the device input recommendations.
4. Select pre-emphasis level by setting the PE0 (CON5) and PE1 (CON6) pins to L or H. Refer to Table 3.

PE1	PE0	Pre-emphasis Level
0	0	Off
0	1	Low
1	0	Medium
1	1	High

Table 3. Pre-emphasis Level Selection

5. Connect the OUT3 outputs to an oscilloscope and view the output signals with an oscilloscope with the bandwidth of at least 5 GHz.

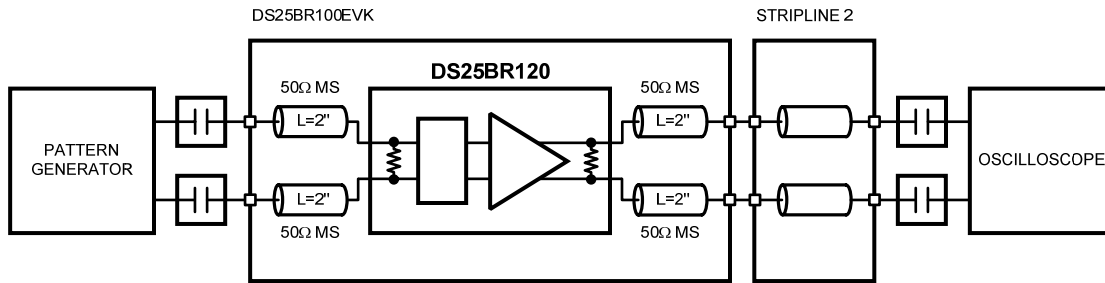
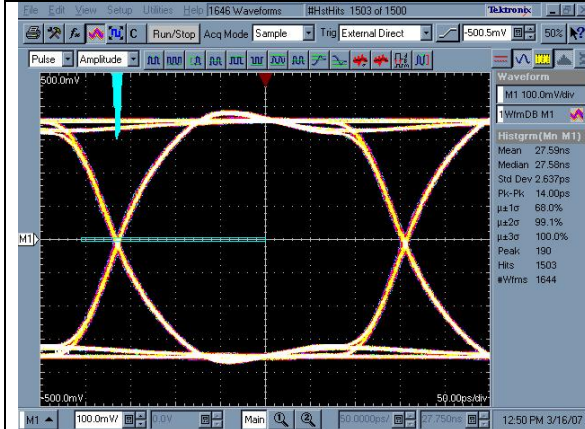


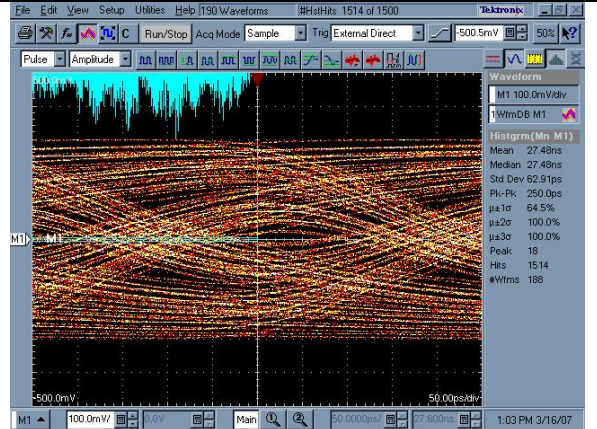
Figure 4. DS25BR120 Test Setup Example

Typical Performance

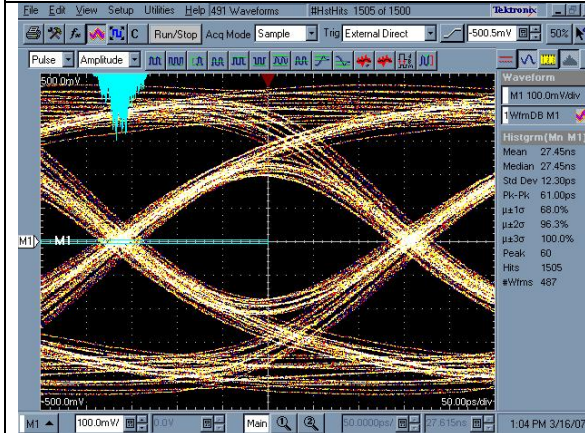
This section of the User Manual shows typical eye diagrams you can expect to see when evaluating the DS25BR100EVK.



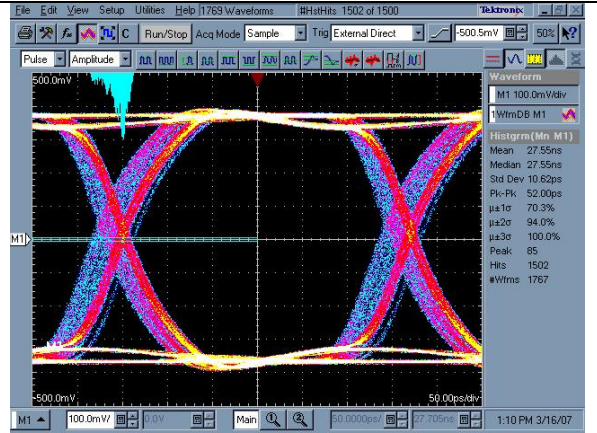
The DS25BRxxx 3.125 Gbps PRBS-7 output eye diagram without any STRIPLINE connected and with PE/EQ = Off



The DS25BRxxx 3.125 Gbps PRBS-7 output eye diagram after the STRIPLINE 3 and with PE/EQ = Off



The DS25BR120 3.125 Gbps PRBS-7 output eye diagram after the STRIPLINE 3 and with PE = High. See Figure 4 for the Setup used.



The DS25BR110 3.125 Gbps PRBS-7 output eye diagram after the STRIPLINE 3 and with EQ = High. See Figure 3 for the Setup used.

ENERCON - BILL OF MATERIALS		TITLE: NATIONAL SEMICONDUCTOR PCBA, DS25BR100EVK , ROHS		PL Number: Z3016-01	Rev: 2	Rev By: BJ	Rev Date: 3/1/2007	PL Status: Released
Main Product: PCBA, DS25BR100EVK , ROHS					Responsible Eng/Mgr:		Creator: Arlene Fox	Creation Date: 10/26/2006

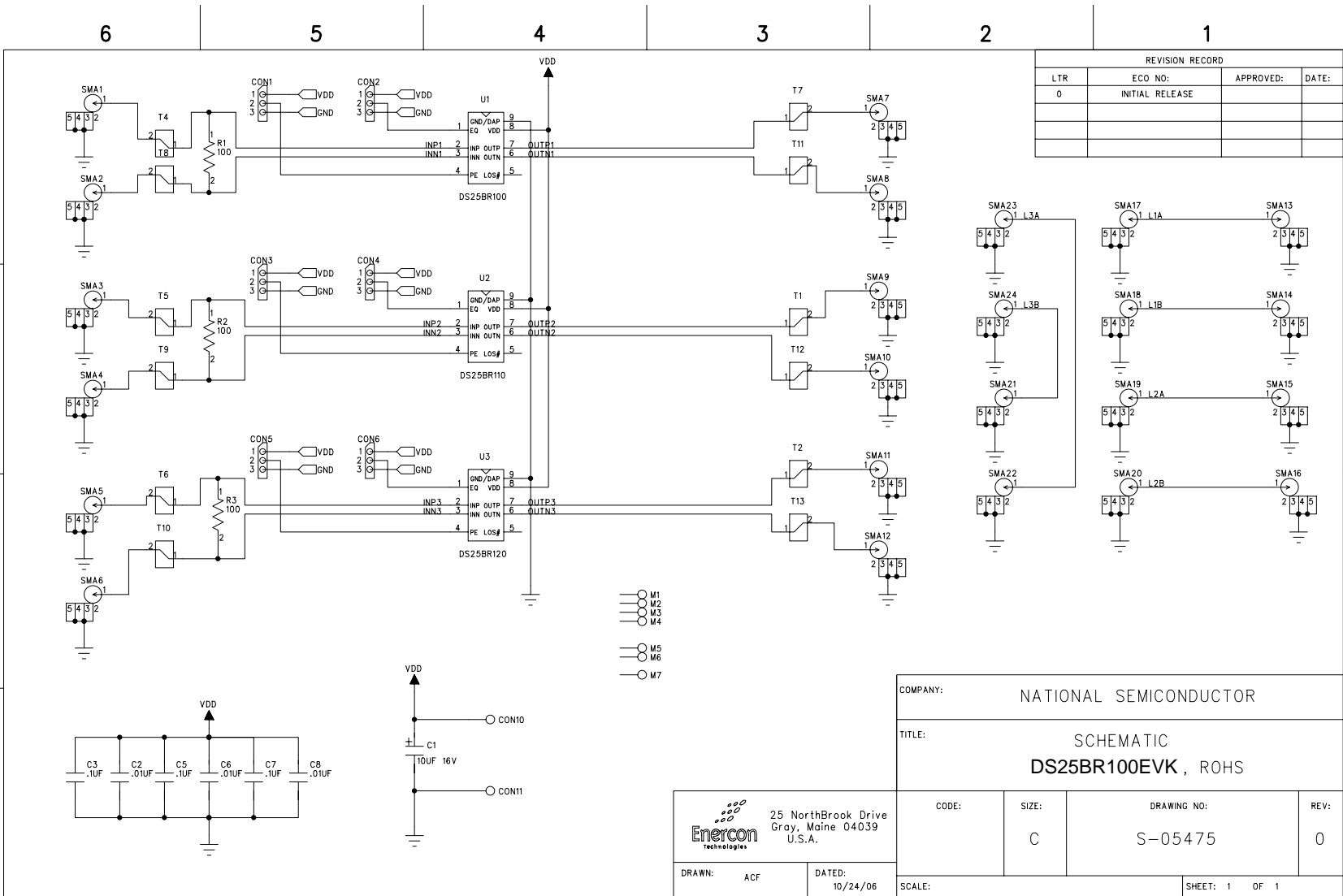
Item	Part Type	Part Number/Value	Mfg	NoSub	Description	Qty	SMT	Ref Des	Notes	Rev
1	PCB	P-05479R0			DS25BR100: 4.50x4.50x.062in, 8 layer	1			Bd: (114.30x 114.30mm) Panel: (4.50x13.70in) (114.30x 347.98mm) 3 bds/panel	0
2										
3	IC	DS25BR100TSD	NAT			1	X	U1	Customer Supplied	0
4	IC	DS25BR110TSD	NAT			1	X	U2	Customer Supplied	0
5	IC	DS25BR120TSD	NAT			1	X	U3	Customer Supplied	0
6										
7										
8	CAP	06035C103KAT	AVX		.01µF, 50V, ±10%, 0603, Ceramic, X7R, Pb-Free	3	X	C2,6,8		0
	<ALT>	C0603C103K5RAC	KEMET		.01µF, 50V, ±10%, 0603, Ceramic, X7R, Pb-Free					
	<ALT>	ECJ-1VB1H103K	PANA		.01µF, 50V, ±10%, 0603, Ceramic, X7R, Pb-Free					
9	CAP	0603YC104KAT	AVX		.1µF, 16V, ±10%, 0603, Ceramic, X7R, Pb- Free	3	X	C3,5,7		0
	<ALT>	C0603C104K3RAC	KEMET		.1µF, 25V, ±10%, 0603, Ceramic, X7R, Pb- Free					
	<ALT>	C0603C104K4RAC	KEMET		.1µF, 16V, ±10%, 0603, Ceramic, X7R, Pb- Free					
	<ALT>	ECJ-1VB1C104K	PANA		.1µF, 16V, ±10%, 0603, Ceramic, X7R, Pb- Free					
	<ALT>	ECJ-1VB1E104K	PANA		.1µF, 25V, ±10%, 0603, Ceramic, X7R, Pb- Free					
10	CAP	TAJA106K016	AVX		10µF, 16V, ±10%, A-Case, Tantalum, Pb- Free	1	X	C1		0
	<ALT>	T491A106K016AT	KEMET		10µF, 16V, ±10%, A-Case, Tantalum, Pb- Free					
11										

ENERCON - BILL OF MATERIALS	TITLE: NATIONAL SEMICONDUCTOR PCBA, DS25BR100EVK , ROHS	PL Number: Z3016-01	Rev: 2	Rev By: BJ	Rev Date: 3/1/2007	PL Status: Released
		Main Product: PCBA, DS25BR100EVK , ROHS		Responsible Eng/Mgr:	Creator: Arlene Fox	Creation Date: 10/26/2006

Item	Part Type	Part Number/Value	Mfg	NoSub	Description	Qty	SMT	Ref Des	Notes	Rev
12	CONN	142-0701-851	EMERSON		SMA, Jack Receptacle, 50 OHM, Pb-Free	24		SMA1-24		0
13	CONN	3267	POMONA		Banana, 1p, Female, Pb-Free	2		CON10,11		0
14	CONN	TSW-103-07-G-S	SAMTEC		Header, 3p, Male, .100"sp, Gold, Pb-Free	6		CON1-6		0
15										
16	STENCL	T-05481R0	ENERCON		STENCIL FABRICATION, DS25BR100-EVK, ROHS	1				0
17										
18	REF	C-05480R0	ENERCON		FABRICATION DWG, DS25BR100-EVK, ROHS					0
19	REF	S-05475R0	ENERCON		SCHEMATIC, DS25BR100-EVK, ROHS					0
20	REF	C-05491R0	ENERCON		PALLET DWG, DS25BR100-EVK, ROHS					0

Notes:

Do Not Stuff Resistors R1, R2, and R3

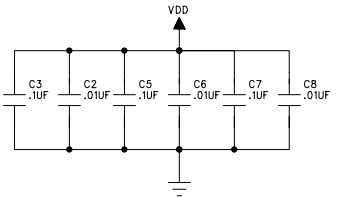
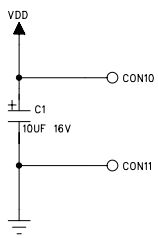


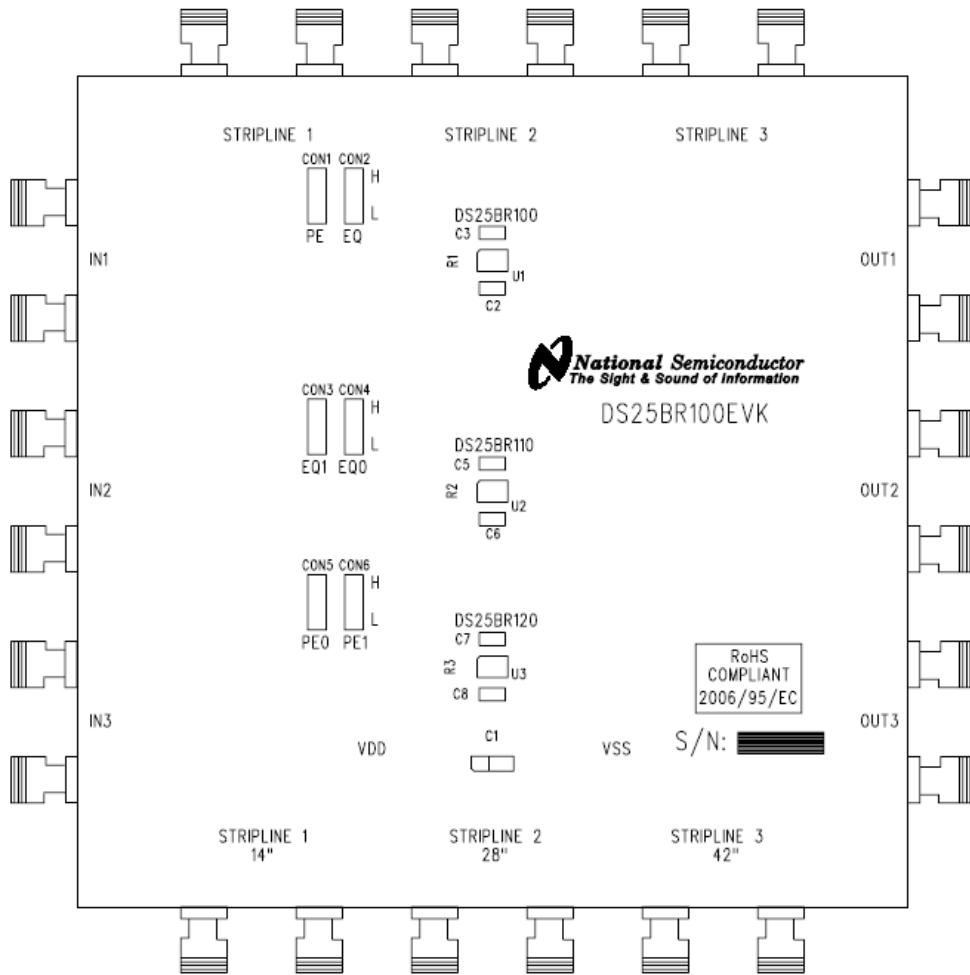
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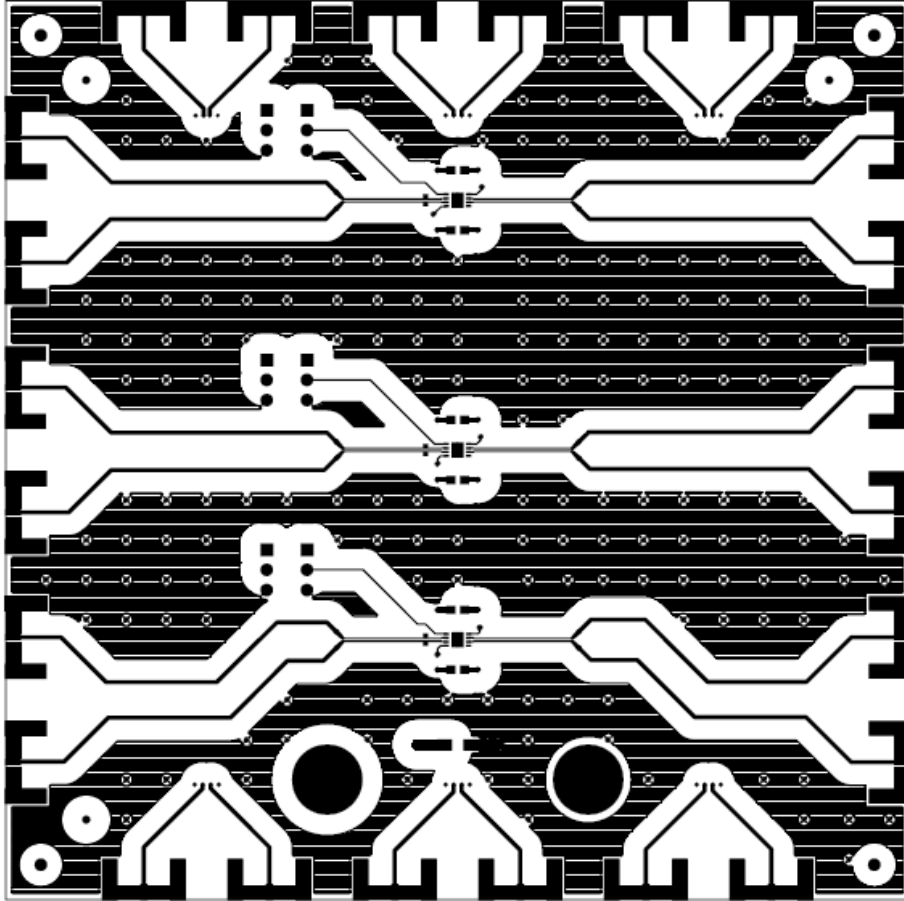
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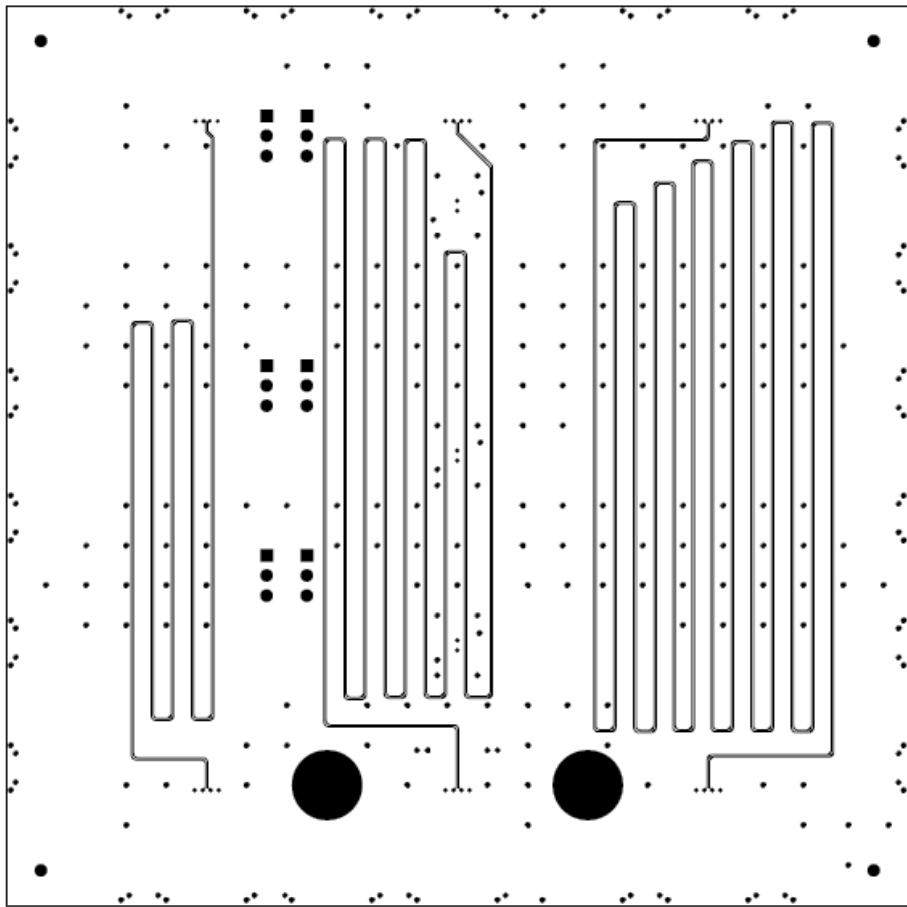
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- M1
- M2
- M3
- M4
- M5
- M6
- M7

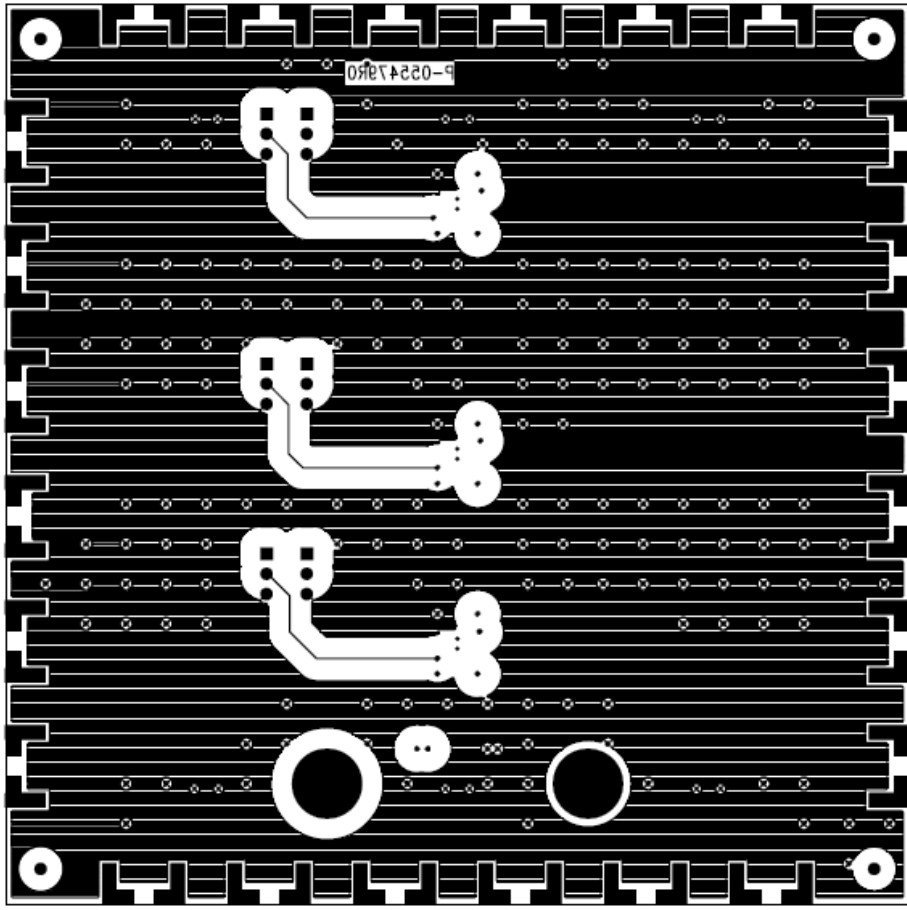








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